

PCN # 238
Initial Notification Date:
July 21, 2022

Product / Process Change Notice

Part Affected:

The TIP112 NPN power transistor.

Extent of Change:

Change in die size from 84 x 84 mils to 89 x 89 mils.

Reason for Change:

As part of Central Semiconductor's supply chain risk mitigation initiative, and in an effort to ensure an uninterrupted supply of product, a change in die size is being made for the product referenced above. Product specifications, quality and reliability are not impacted by this change.

Effect of Change:

This change does not affect the fit, form or function of the device.

Qualification:

Based on standards JESD22 and MIL-STD-750, qualification testing is in-process and data will be provided upon successful completion.

Earliest Effective Date of Change:

To be determined after completion of qualification testing.

As per JEDEC standard JESD46, Customer Notification of Product/Process Changes by Solid-State Suppliers, a lack of acknowledgement of a PCN within thirty (30) days constitutes acceptance of the change.

The undersigned acknowledges and accepts Central Semiconductor's Product/Process Change Notification (PCN).

Company Name:	
Address:	
Printed Name:	
Title:	
Signature:	
Date:	